

(<)	Pre	limi	nary	Sp	ecifi	cation	S
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Module	15.6" HD 16:9 Color TFT-LCD with LED Backlight design			
Model Name	B156XTK01.0 (H/W:0A)			
Note (♠)	o-TP Display			

Customer	Date				
Checked & Approved by	Date				
Note: This Specification is subject to change without notice.					

Approved by	Date				
Prepared by	Date				
<u>Hsiang YI Chen</u>	<u>2014/12/22</u>				
NBBU Marketing Division AU Optronics corporation					



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Record of Revision

Vei	Version and Date Page		Old description	New Description	Remark
0.1	2014/12/22	All	First Edition for Customer		



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electronic breakdown.



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2. General Description

B156XTK01.0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x 768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are eDP(Embedded DisplayPort) interface compatible.

B156XTK01.0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

Items	Unit	Specificatio	ns			
Screen Diagonal	[mm]	394.9				
Active Area	[mm]	344.23 x 193.54				
Pixels H x V		1366 x 3(RG	B) x 768			
Pixel Pitch	[mm]	0.252 x 0.252	2			
Pixel Format		R.G.B. Vertic	cal Stripe			
Display Mode		Normally W	hite			
White Luminance (ILED= 21 mA) (Note: ILED is LED current)	[cd/m ²]			ige) (Total Sc age) (Total S		
Luminance Uniformity		1.25 max. (5	points)			
Contrast Ratio		500:1 typ				
Response Time	[ms]	8 typ/16 Mc	1X			
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	3.6W				
Weight	[Grams]	380 max.				
Physical Size			Min.	Тур.	Max.	
Include bracket		Length	359.00	359.50	360.00	
(Panel only)	[mm]	Width	223.30	223.80	224.30	
Thicknessss	- [[[]]]	Thicknessss				
Electrical Interface		1 Lane eDP				
Glass Thickness	[mm]	0.4				
Surface Treatment		HC, hardne	ss 3H			
Support Color		262K colors (RGB 6-bit)				
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60				
RoHS Compliance		RoHS Comp	RoHS Compliance			



2.1.1 General Touch Specification

Items	Specifications	Unit	
Type of Touch Sensor	Projective Capacitive (on cell)		
Panel Size	15.6''		
TP View Area	NA	mm	
TP Active Area	347.208 x 196.521	mm	
Interface	USB or I2C		
Report Rate	Follow win8 – 100Hz	Hz	
Multi-Touch Point	10 points		
Input method	Finger		
Touch panel sensor IC	EETi (EXC3062)		
Channel	69 x 39		
Distance between 2 point	Follow win8	mm	
Surface hardness	3	Н	
TP F/W version	TBD		



2.2 Optical Characteristics

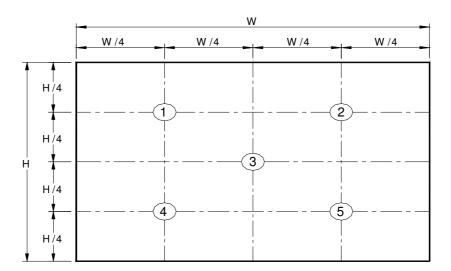
The optical characteristics are measured under stable conditions at 25% (Room Temperature) :

Item		Symbol	Conditions	Min.	Тур.	Мах.	Unit	Note
White Lumino			5 points average	170	200	-	cd/m²	1, 4, 5.
		Θ _R Θ _L	Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	degree	
Viewing Ar	ngle	Ψн Ψι	Vertical (Upper) CR = 10 (Lower)	10	15	-		4, 9
		Ψι	· · · ·	30	35	-		
Luminance Un	itormity	δ ₅P	5 Points	-	-	1.25		1, 3, 4
Luminance Un	Luminance Uniformity		13 Points	-	=	1.60		2, 3, 4
Contrast Ro	Contrast Ratio			400	500	_		4, 6
Cross tal	Cross talk					4		4, 7
Response T	ime	T _{RT}	Rising + Falling	-	8	16		
	Red	Rx		TBD	TBD	TBD		
		Ry		TBD	TBD	TBD		
	Green	Gx		TBD	TBD	TBD		
Color / Chromaticity	Green	Gy		TBD	TBD	TBD		
Coodinates	Bx	Bx	CIE 1931	TBD	TBD	TBD		4
	Blue	Ву		TBD	TBD	TBD		
	White	Wx		0.283	0.313	0.343		
		Wy		0.299	0.329	0.359		
NTSC		%		_	45	-		

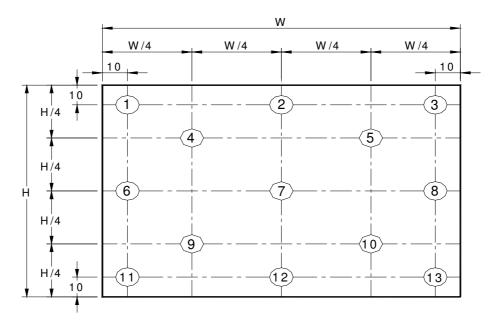
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Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

2	Maximum Brightness of five points
$\delta_{W5} =$	Minimum Brightness of five points
2	Maximum Brightness of thirteen points
$\delta_{\text{W13}} =$	Minimum Brightness of thirteen points

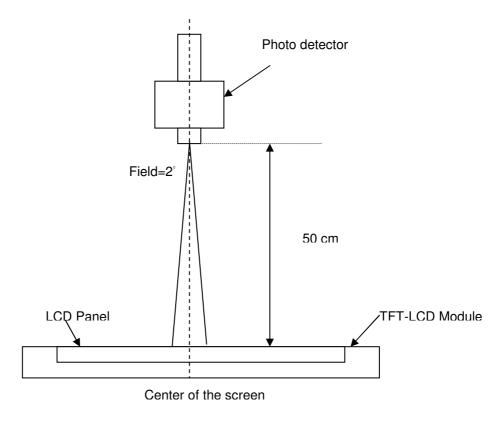
Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after

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lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Brightness on the "White" state Contrast ratio (CR)=

Briahtness on the "Black" state

Note 7: Definition of Cross Talk (CT)

$$CT = | Y_B - Y_A | / Y_A \times 100 (\%)$$

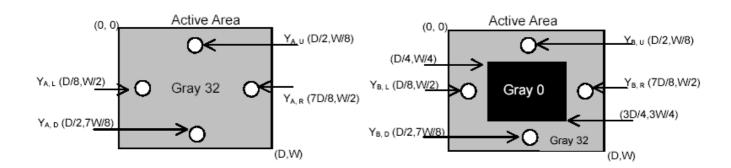
Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

 $Y_B = Luminance$ of measured location with gray level 0 pattern (cd/m₂)

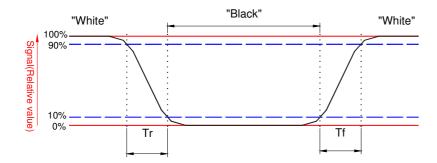
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Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

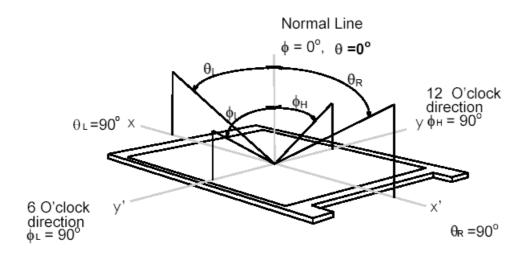




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Note 9. Definition of viewing angle

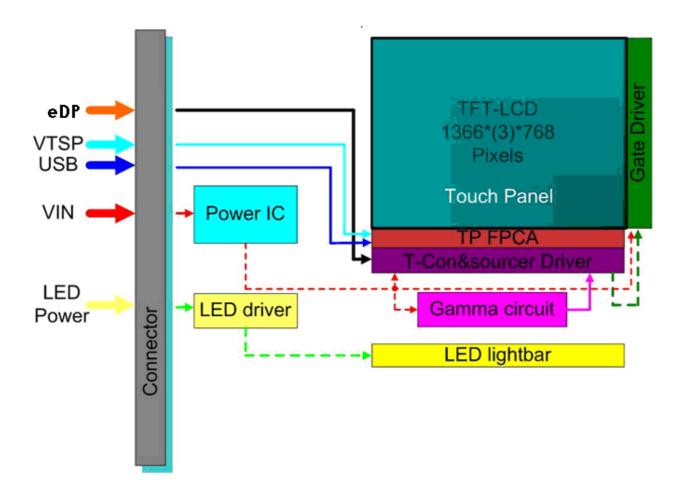
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 15.6 inches wide Color TFT/LCD 40 Pin (One CH/connector Module)





4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

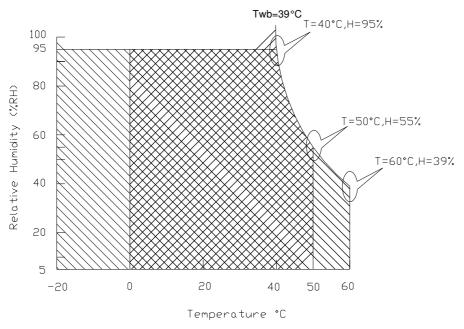
<u> </u>									
Item	Symbol	Min	Max	Unit	Conditions				
Operating	TOP	0	+50	[°C]	Note 4				
Operation Humidity	HOP	5	95	[%RH]	Note 4				
Storage Temperature	TST	-20	+60	[°C]	Note 4				
Storage Humidity	HST	5	95	[%RH]	Note 4				

Note 1: At Ta (25° C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+



5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

Input power specifications are as follows;

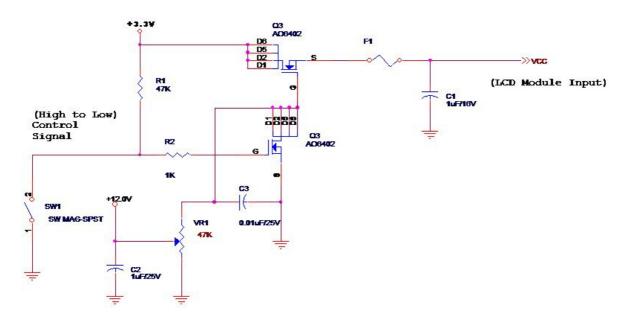
The power specification are measured under 25°C and frame frenquency under 60Hz

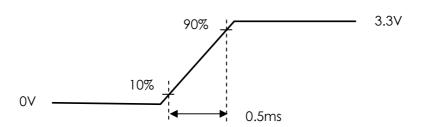
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	-	0.8	[Watt]	Note 1
IDD	IDD Current	-	-	250	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern at 3.3V driving voltage. (Pmax=V3.3 x lblack)

Typical Measurement Condition: Mosaic Pattern

Note 2: Measure Condition





Vin rising time

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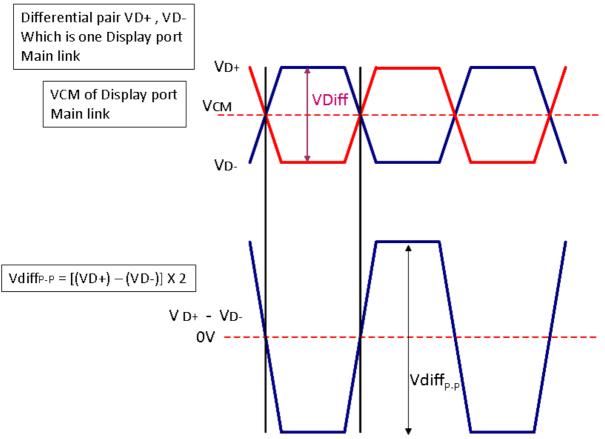


5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Display Port main link signal:



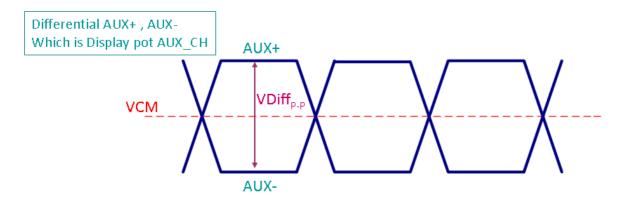
	Display port main link				
		Min	Тур	Max	unit
VCM	RX input DC Common Mode Voltage		0		V
VDiff _{P-P}	Peak-to-peak Voltage at a receiving Device	100		1320	mV

Fallow as VESA display port standard V1.1a

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Display Port AUX_CH signal:



	Display port AUX_CH				
		Min	Тур	Max	unit
VCM	AUX DC Common Mode Voltage		0		٧
VDiff _{P-P}	AUX Peak-to-peak Voltage at a receiving Device	0.4	0.6	0.8	V

Fallow as VESA display port standard V1.1a.

Display Port VHPD signal:

	Display port VHPD				
		Min	Тур	Max	unit
VHPD	HPD Voltage	2.25		3.6	V

Fallow as VESA display port standard V1.1a.



5.2 Touch Sensor

5.2 Touch Sensor Power Consumption

Items	Symbol	Sp	ecificatio	ons	Unit	Notes
HOTHS	O y 11 10 O 1	Min.	Тур.	Max.		110103
Touch Panel Power Supply	VDD	4.75	5	5.25	V	



5.3 Backlight Unit 5.3.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	2.8	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	15,000	-	-	Hour	(Ta=25°C), Note 2 I _F =21 mA

Note 1: Calculator value for reference PLED = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.3.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	5.0	12.0	21.0	[Volt]	
LED Enable Input High Level	VLED_EN	2.5	-	5.5	[Volt]	
LED Enable Input Low Level	*Note 1	-	-	0.5	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	Define as
PWM Logic Input Low Level	*Note 1	ı	ı	0.5	[Volt]	Connector
PWM Input Frequency	FPWM	200	1K	10K	Hz	(Ta=25°C)
PWM Duty Ratio	Duty	5	ŀ	100	%	

Note 1: Recommend system pull up/down resistor no bigger than 10kohm



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

		1									13	66	
1st Line	R	G	В	R	G	В		R	G	В	R	G E	3
		1			•		•		•				\rceil
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	\vdash		П									Ť	
768th Line	R	G	В	R	G	В		R	G	В	R	GE	В



6.2 Integration Interface Requirement

6.2.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	JAE or Compatible
Type / Part Number	JAE, HD1S040HA1 or compatible
Mating Housing/Part Number	IPEX 20453040T-11 or compatible

6.2.2 Pin Assignment

eDP lane is a differential signal technology for LCD interface and high speed data transfer device.

PIN NO	Symbol	Function
1	NC	No Connect
2	H_GND	High Speed Ground
3	Lane1_N	Comp Signal Lane 1
4	Lane1_P	True Signal Link Lane 1
5	H_GND	High Speed Ground
6	Lane0_N	Comp Signal Link Lane 0
7	Lane0_P	True Signal Link Lane 0
8	H_GND	High Speed Ground
9	AUX_CH_P	True Signal Auxiliary Ch.
10	AUX_CH_N	Comp Signal Auxiliary Ch.
11	H_GND	High Speed Ground
12	LCD_VCC	LCD logic and driver power
13	LCD_VCC	LCD logic and driver power
14	LCD_Self_Test	LCD Panel Self Test Enable
15	LCD GND	LCD logic and driver ground
16	LCD GND	LCD logic and driver ground
17	HPD	HPD signale pin
18	BL_GND	Backlight_ground
19	BL_GND	Backlight_ground
20	BL_GND	Backlight_ground
21	BL_GND	Backlight_ground



22	BL_Enable	Backlight On / Off
23	BL PWM DIM	System PWM signal Input
24	NC	No connect (Reverse for AUO TEST only)
25	NC	No connect (Reverse for AUO TEST only)
26	BL_PWR	Backlight power
27	BL_PWR	Backlight power
28	BL_PWR	Backlight power
29	BL_PWR	Backlight power
30	NC	No Connect (Reserved for CM)
31	TP_D-	USB Data- for Touch
32	TP_D+	USB Data+ for Touch
33	GND	Ground-Shield
34	VTSP	Touch panel power supply (5V)
35	VTSP	Touch panel power supply (5V)
36	NC/TP_EN	No Connection (Reserve for Touch function enable)
37	TP_CLK	I2C Clock for Touch (NC for USB input)
38	TP_Data	I2C Data for Touch (NC for USB input)
39	INT	Interrupt for Touch (NC for USB input)
40	RST	Reset for Touch (NC for USB input)

Note1: start from right side

Note2: Input signals shall be low or High-impedance state when VDD is off.



6.3 Interface Timing

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit	
Frame Rate		-	-	60	-	Hz	
Clock frequency		1/TClock	66.9	72	80	MHz	
	Period	T ∨	788	824	768+A		
Vertical	Active	T vD		768			
Section	Blanking	T∨B	20	56	Α		
	Period	T _H	1416	1456	1366+B		
Horizontal	Active	T HD		1366		T Clock	
Section	Blanking	T HB	50	90	В		

Note 1: The above is as optimized setting

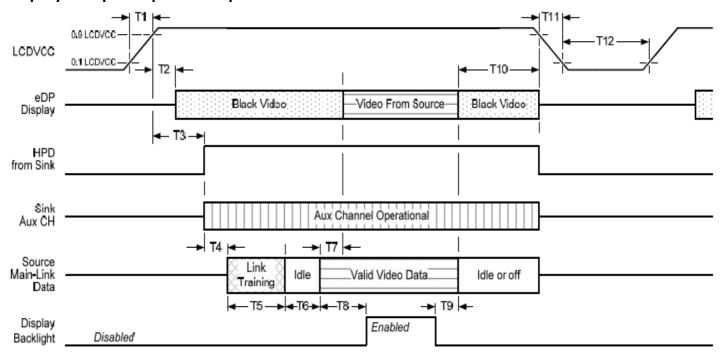
Note 2: The maximum clock frequency = (1366+B)*(768+A)*60 < 80MHz



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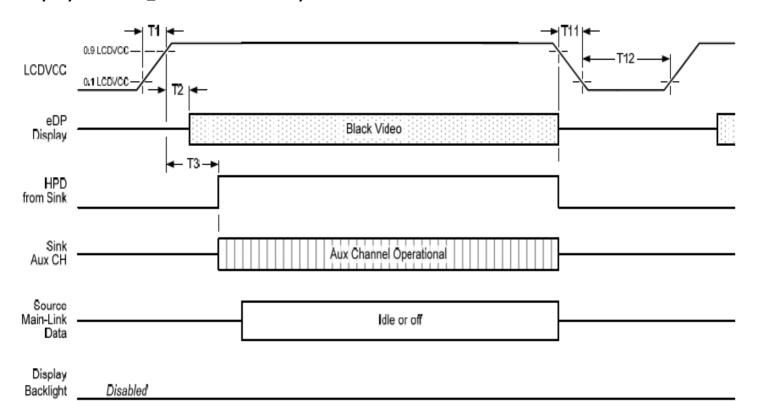
6.4 Power sequence

Display Port panel power sequence:



Display port interface power up/down sequence, normal system operation

Display Port AUX_CH transaction only:



Display port interface power up/down sequence, AUX_CH transaction only



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Display Port panel power sequence timing parameter:

Timing	Description	Reqd. by	Limits			Notes	
parameter			Min.	Тур.	Max.	Mutes	
T1	power rail rise time, 10% to 90%	source	0.5ms		10ms		
Т2	delay from LCDVDD to black video generation	sink	0ms		200ms	prevents display noise until valid video data is received from the source	
Т3	delay from LCDVDD to HPD high	sink	0ms		200ms	sink AUX_CH must be operational upon HPD high.	
Т4	delay from HPD high to link training initialization	source				allows for source to read link capability and initialize.	
Т5	link training duration	source				dependant on source link to read training protocol.	
Т6	link idle	source				Min accounts for required BS-Idle pattern. Max allows for source frame synchronization.	
Т7	delay from valid video data from source to video on display	sink	0ms		50ms	max allows sink validate video data and timing.	
Т8	delay from valid video data from source to backlight enable	source				source must assure display video is stable.	
Т9	delay from backlight disable to end of valid video data	source				source must assure backlight is no longer illuminated.	
T10	delay from end of valid video data from source to power off	source	0ms		500ms		
T11	power rail fall time, 905 to 10%	source			10ms		
T12	power off time	source	500ms				

Note1: The sink must include the ability to generate black video autonomously. The sink must automatically enable black video under the following conditions:

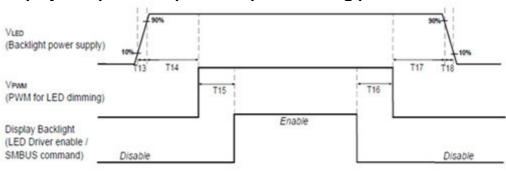
- -upon LCDVDD power on (with in T2 max)-when the "Novideostream_Flag" (VB-ID Bit 3) is received from the source (at the end of T9).
- -when no main link data, or invalid video data, is received from the source. Black video must be displayed within 64ms (typ) from the start of either condition. Video data can be deemed invalid based on MSA and timing information, for example.

Note 2: The sink may implement the ability to disable the black video function, as described in Note 1, above, for system development and debugging purpose.

Note 3: The sink must support AUX_CH polling by the source immediately following LCDVDD power on without causing damage to the sink device (the source can re-try if the sink is not ready). The sink must be able to respond to an AUX_CH transaction with the time specified within T3 max.



Display Port panel B/L power sequence timing parameter:



Note: When the adapter is hot plugged, the backlight power supply sequence is shown as below.

VLED (Backlight power supply) (Hot Plug)	50% VLED	10% TOO	
	119	120	

	Min (ms)	Max (ms)
T13	0.5	10
T14	10	2-3
T15	10	
T16	10	121
T17	10	0+6
T18	0.5	10
T19	1*	828
T20	1*	0-0

Seamless change: T19/T20 = 5xT_{PWM}*

*T_{PWM}= 1/PWM Frequency



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7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

• Frequency: 10 - 500Hz Random

• Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

• Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature	T 40% 00% PU 0001	
Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature		
Operation	Ta= 50°C, Dry, 300h	
Low Temperature		
Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock		
Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed.

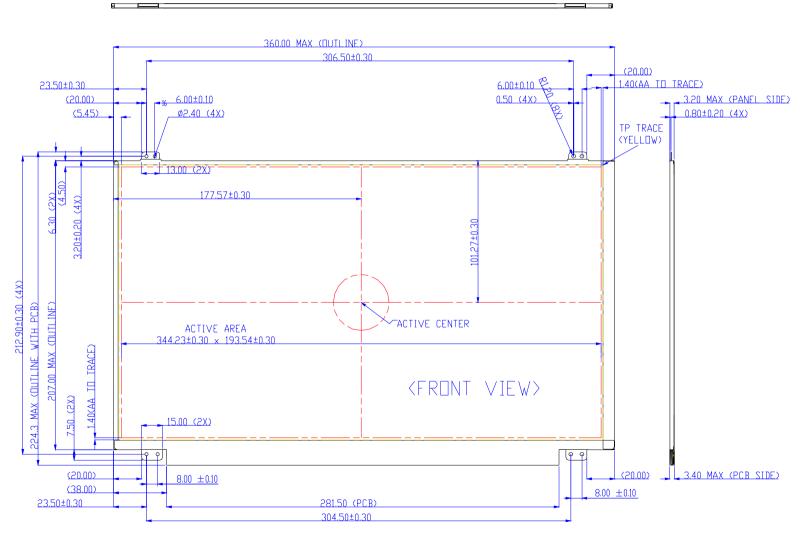
Self-recoverable. No data lost, No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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- 8. Mechanical Characteristics
- **8.1 LCM Outline Dimension**
- 8.1.1 Standard Front View



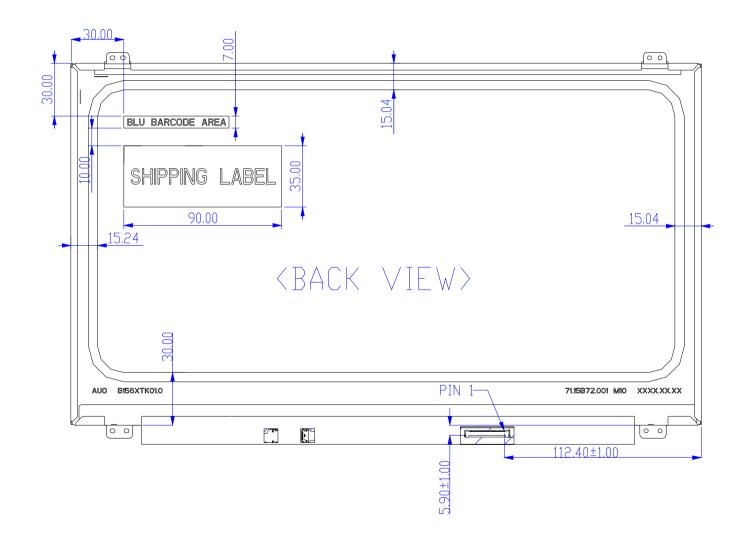
The drawing following 2D standard drawing and remark.

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8.1.2 Standard Rear View





9. Shipping and Package

9.1 Shipping Label Format





B156XTK01.0

Manufactured MM/WW Model No: B156XTK01.0 AU Optronics MADE IN CHINA (\$01)

H/W: 0A F/W:1

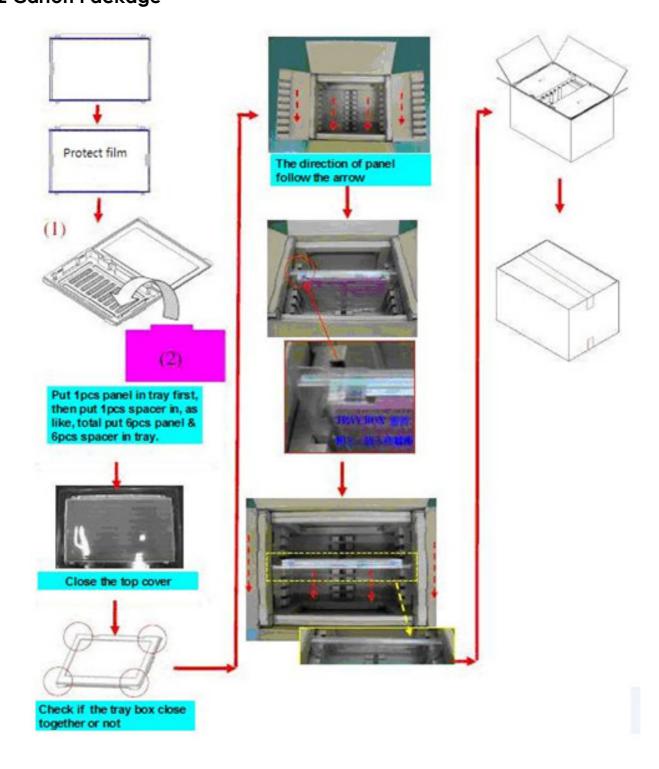
C 队 US E204356





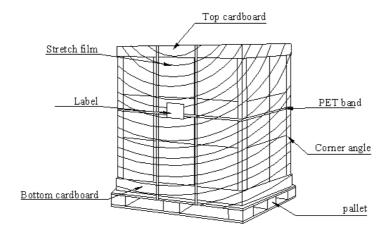








9.3 Shipping Package of Palletizing Sequence





10. Appendix: EDID Description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	EC	11101100	236	
0B	hex, LSB first	10	00010000	16	
0C	32-bit ser #	00	00000000	0	
0D	02 0.000 n	00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	00	00000000	0	
11	Year of manufacture	18	00011000	24	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	04	00000100	4	
14	Video input def. (digital I/P, non-TMDS, CRGB)	95	10010101	149	
15	Max H image size (rounded to cm)	22	00100010	34	
16	Max V image size (rounded to cm)	13	00010011	19	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	02	00000010	2	
19	Red/green low bits (Lower 2:2:2:2 bits)	BB	10111011	187	
1A	Blue/white low bits (Lower 2:2:2:2 bits)	F5	11110101	245	
1B	Red x (Upper 8 bits)	94	10010100	148	
1C	Red y/ highER 8 bits	55	01010101	85	
1D	Green x	54	01010100	84	
1E	Green y	90	10010000	144	
1F	Blue x	27	00100111	39	
20	Blue y	23	00100011	35	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	0000001	1	
27	, and the second	01	0000001	1	
28	Standard timing #2	01	0000001	1	
29	¥."	01	00000001	1	



	,		1		i
2 A	Standard timing #3	01	0000001	1	
2B		01	00000001	1	
2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	0000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	0000001	1	
31		01	0000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	0000001	1	
36	Pixel Clock/10000 LSB	14	00010100	20	
37	Pixel Clock/10000 USB	1E	00011110	30	
38	Horz active Lower 8bits	56	01010110	86	
39	Horz blanking Lower 8bits	CE	11001110	206	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	00	00000000	0	
3C	Vertical Blanking Lower 8bits	30	00110000	48	
	Vert Act : Vertical Blanking (upper 4:4			· · ·	
3D	bit)	30	00110000	48	
3E	HorzSync. Offset	80	00001000	8	
3F	HorzSync.Width	0A	00001010	10	
40	VertSync.Offset : VertSync.Width	36	00110110	54	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	58	01011000	88	
43	Vertical Image Size Lower 8bits	C1	11000001	193	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	0000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49					
	descriptor #2	00	00000000	0	
4A 4B		00 0F	00000000	0 15	
			00001111		
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	



58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	0000000	0	
5B	descriptor #3	00	0000000	0	
5C	adddiptor we	00	00000000	0	
5D		FE	11111110	254	
5E		00	0000000	0	
5F	Manufacture	41	01000001	65	А
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62	Manadadad	0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	35	00110101	53	5
74	Manufacture P/N	36	00110110	54	6
75	Manufacture P/N	58	01011000	88	X
76	Manufacture P/N	54	01010100	84	Т
77	Manufacture P/N	4B	01001011	75	K
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	31	00110001	49	1
7A	Manufacture P/N	2E	00101110	46	
7B	Manufacture P/N	30	00110000	48	0
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	F2	11110010	242	